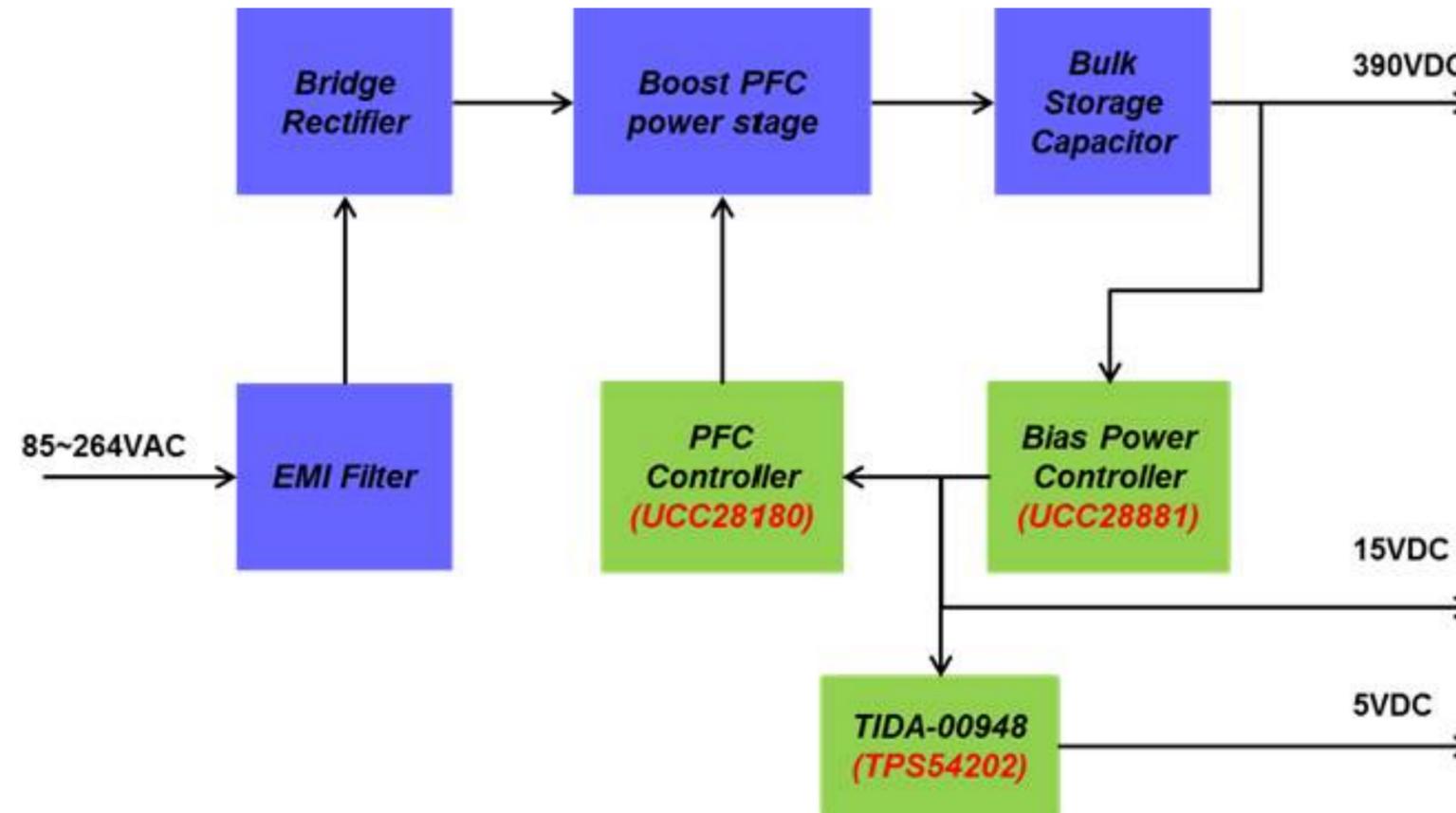


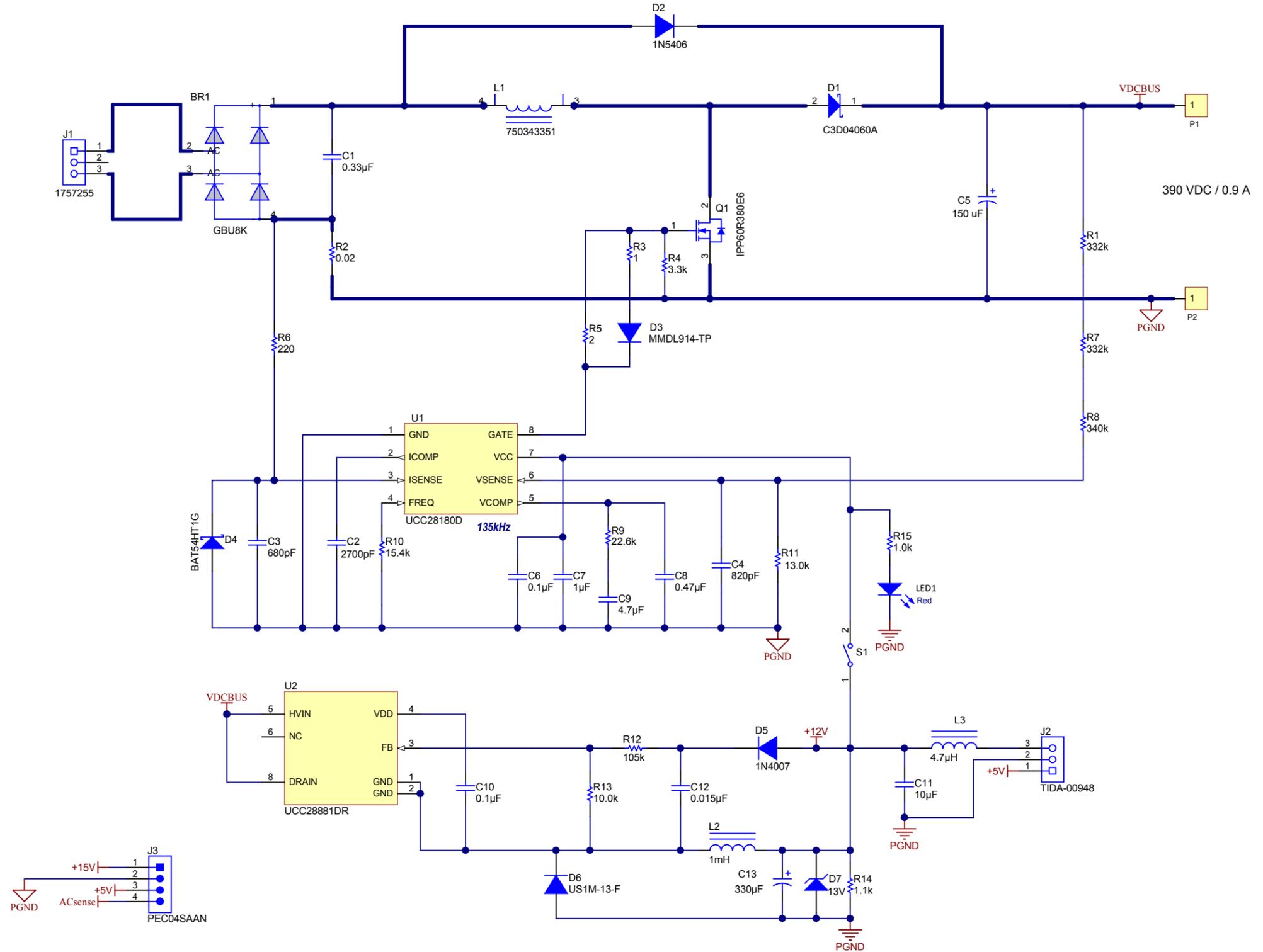
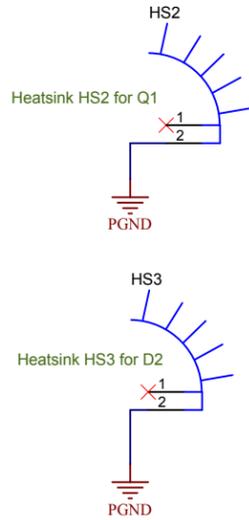
Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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Orderable: No	Designed for: Public Release	Mod. Date: 11/17/2016	 http://www.ti.com
TID #: TIDA-00776	Project Title: 350w CCM PFC for Refrigerator	Sheet: 1 of 3	
Number: TIDA-00776	Rev: E1	Assembly Variant: [No Variations]	Size: B
SVN Rev: Version control disabled	File: CoverSheet.SchDoc	Contact: http://www.ti.com/support	© Texas Instruments 2016
Drawn By:	Engineer: Jason Tao		

NOTES:
 LINE INPUT VOLTAGE: 85VRMS - 264VRMS, 47Hz - 63Hz
 PEAK INPUT CURRENT: 7A
 OUTPUT VOLTAGE: 390VDC nominal
 MAXIMUM OUTPUT POWER: 350W



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Orderable: No	Designed for: Public Release	Mod. Date: 11/15/2016
TID #: TIDA-00776	Project Title: 350w CCM PFC for Refrigerator	
Number: TIDA-00776	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 2 of 3
Drawn By:	File: TIDA-00776 Rev B.SchDoc	Size: B
Engineer: Jason Tao	Contact: http://www.ti.com/support	



H1 NY PMS 440 0025 PH
 H2 NY PMS 440 0025 PH
 H3 NY PMS 440 0025 PH
 H4 NY PMS 440 0025 PH

H5 1902C
 H6 1902C
 H7 1902C
 H8 1902C

H9 SJ-5303 (CLEAR)
 H10 SJ-5303 (CLEAR)
 H11 SJ-5303 (CLEAR)
 H12 SJ-5303 (CLEAR)

FID1
 FID2
 FID3

PCB Number: TIDA-00776
 PCB Rev: E1

PCB LOGO
 Texas Instruments

PCB LOGO
 Pb-Free Symbol

You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ2
 Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
 Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
 Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Orderable: No	Designed for: Public Release	Mod. Date: 8/4/2015
TID #: TIDA-00776	Project Title: 350w CCM PFC for Refrigerator	
Number: TIDA-00776	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 3 of 3
Drawn By:	File: TID_Hardware.SchDoc	Size: B
Engineer: Jason Tao	Contact: http://www.ti.com/support	



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